

PRODUCT NUMBER
77773-YXXLF

RoHS COMPATIBLE, SEE NOTE 7

PLATING

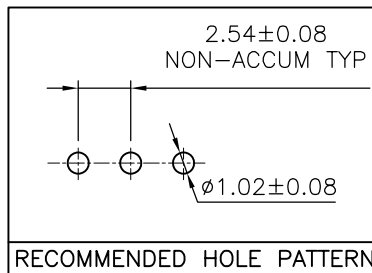
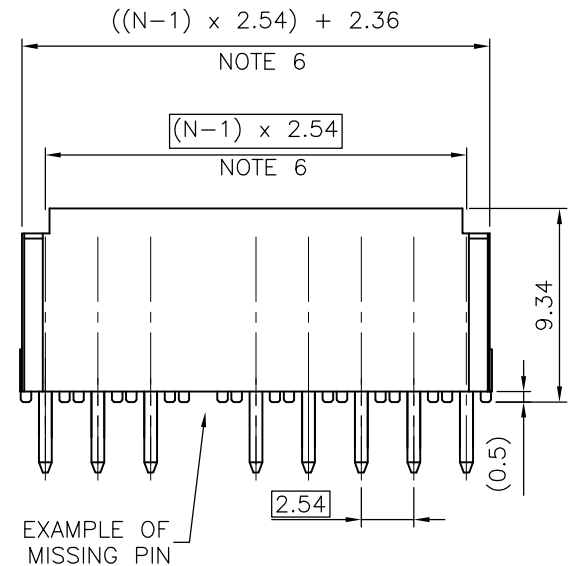
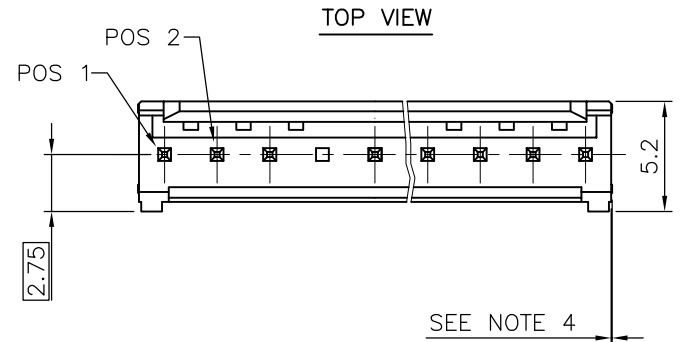
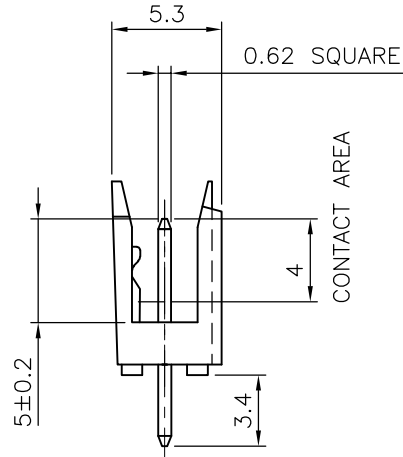
3=0.76µm GOLD/GXT ON CONTACT AREA
2µm MIN MATTE TIN ON TAIL
4=2µm MIN MATTE TIN FULL PLATED
1.27µm Ni MIN UNDERPLATING

STYLE	SIZE	OMIT PIN POSITION FROM TOP VIEW
01	1x09	2
02	1x35	4;5;6;7;8;12;13;14;15;16;20;21;22;23;24;28;32
03	1x21	2;4;6;8;10;12;14;16;18;20;21
04	1x21	1;2;4;6;8;10;12;14;16;18;20
05	1x10	8
06	1x06	1
07	1x08	7
08	1x04	2
09	1x04	3
12	1x21	2;4;6;8;10;12;14;16;18;20
13	1x05	2;4
14	1x03	2
15	1x25	1;3;5;7;9;11;13;15;17;19;21;23;25
16	1x07	5

NOTES:

- BODY MATERIAL: POLYESTER 30% GLASSFILLED COLOR BLUE, FLAME RETARDANT PER UL-94 V0.
- CONTACT MATERIAL: PHOSPHOR BRONZE.
- 15N MIN PIN RETENTION IN EITHER DIRECTION
- 0.6 MAX PROTRUSION PERMITTED AT 4 PLACES
- PACKAGING :
- POLYBAGS FROM 02 TO 18 POSITIONS
- TUBE FROM 19 TO 36 POSITIONS
- TO DETERMINE DIMENSIONS :
N = NUMBER OF POSITIONS PER ROW
EXAMPLE : 8 POS N x 2.54 = 20.32mm
- RoHS COMPATIBLE PRODUCT SPECIFICATIONS

- PLATING:
- "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.
- MANUFACTURING PROCESS COMPATIBILITY
- THE HOUSING WILL WITHSTAND EXPOSURE TO 245°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
- LABELING:
- MEETS PACKAGING SPECS AS PER GS-14-920
- LEGAL STATEMENT: SEE GS-47-0004



mat'l. code SEE P/N		surface ISO 1302	tolerance ISO 406 ISO 1101	projection mm	product family DUBOX HDR
ltr	ecn no	dr	date	tolerances unless otherwise specified	title DUBOX,SR,STR SELECTIVELY LOADED
V	F08-0147	YOV	08.04.14	angles .X ±0.3	dwg no 77773
W	F09-0028	LMU	09.03.11	linear .XX ±0.15	
X	B-19285	AMA	14.11.03	.XXX ±0.05	sheet 1 of 1
Y	F-21810	AMA	15.06.19	dr COMPAGNON J 95.03.06	size A3
AA	F-22862	LMU	15.12.22	enr PHAMVAN JM 95.03.06	type CUSTOMER Drawing
AB	F-36003	LMU	20.01.29	chr JMC 95.04.04	
				appd JMP 95.04.04	
sheet index	revision sheet				